

Application : Suitable all most of chipset; Good companion for high-power LAN routing relay graphics

Fin edges polished smooth, cooling double-sided silicone and there is no flash.

The design is more reasonable, cube fin array can increase the cooling area.

Product Features:

- 1.copper material;
- 2.super thin size ;
3. large heat dissipation area;
4. strong adhesive;
- 5.heat dissipation is used widely

